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CLAIMS

1. A thin film forming apparatus (100) including a substrate support (10) for mounting a substrate (P) on which a thin film is to be formed, and a chamber (30) which encloses the substrate support (10) and has proper operation conditions, comprising:

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adsorption means (S) attached to surfaces of components within the thin film forming apparatus except the substrate (P).

- 2. The apparatus as claimed in claim 1, wherein each of the adsorption means (S) is constructed by applying a solder metal material (I) on a surface of a metal base material (B).
 - 3. The apparatus as claimed in claim 1, wherein each of the adsorption means (S) is constructed by applying a solder metal material (I) on a surface of a synthetic resin base material (B).
 - 4. The apparatus as claimed in claim 2 or 3, wherein a plurality of grooves are formed on the surface of the base material (B).
- 5. The apparatus as claimed in claim 2 or 3, wherein a plurality of protrusions are formed on the surface of the base material (B).
 - 6. The apparatus as claimed in claim 2 or 3, wherein the base material (B) is in the form of a net.